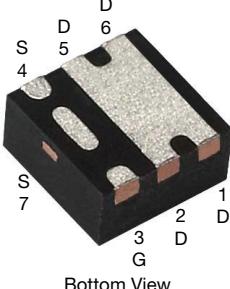
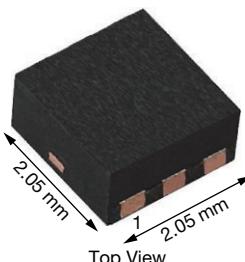


## N-Channel 30 V (D-S) MOSFET

<b>PRODUCT SUMMARY</b>			
<b>V<sub>DS</sub> (V)</b>	<b>R<sub>DS(on)</sub> (Ω) Max.</b>	<b>I<sub>D</sub> (A) <sup>a</sup></b>	<b>Q<sub>g</sub> (TYP.)</b>
30	0.0200 at V <sub>GS</sub> = 4.5 V	12	11.6 nC
	0.0263 at V <sub>GS</sub> = 2.5 V	12	

**PowerPAK® SC-70-6L Single**

**Marking Code:** AZ

**Ordering Information:**

SiA472EDJ-T1-GE3 (lead (Pb)-free and halogen-free)

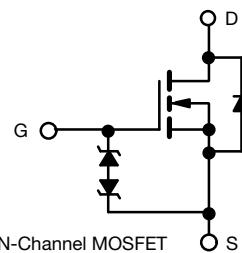
**FEATURES**

- TrenchFET® Power MOSFET
- Thermally enhanced PowerPAK® SC-70 package
  - Small footprint area
- Typical ESD performance 2500 V HBM
- 100 % R<sub>G</sub> and UIS tested
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
COMPLIANT  
HALOGEN  
FREE

**APPLICATIONS**

- Load switch, OVP switch
- Boost converters
- DC/DC converters


**ABSOLUTE MAXIMUM RATINGS** (T<sub>A</sub> = 25 °C, unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V <sub>DS</sub>	30	V
Gate-Source Voltage	V <sub>GS</sub>	± 12	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C	12 <sup>a</sup>	A
	T <sub>C</sub> = 70 °C	12 <sup>a</sup>	
	T <sub>A</sub> = 25 °C	11 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C	8.8 <sup>b, c</sup>	
Pulsed Drain Current (t = 300 μs)	I <sub>DM</sub>	30	
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	12 <sup>a</sup>	
	T <sub>A</sub> = 25 °C	2.9 <sup>b, c</sup>	
Avalanche Current	I <sub>AS</sub>	15	
Single Pulse Avalanche	E <sub>AS</sub>	11.25	mJ
Maximum Power Dissipation	T <sub>C</sub> = 25 °C	19.2	W
	T <sub>C</sub> = 70 °C	12.3	
	T <sub>A</sub> = 25 °C	3.5 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C	2.2 <sup>b, c</sup>	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to 150	°C
Soldering Recommendations (Peak Temperature) <sup>d, e</sup>		260	

**THERMAL RESISTANCE RATINGS**

PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum Junction-to-Ambient <sup>b, f</sup>	t ≤ 5 s	R <sub>thJA</sub>	28	36
Maximum Junction-to-Case (Drain)	Steady State	R <sub>thJC</sub>	5.3	6.5

**Notes**

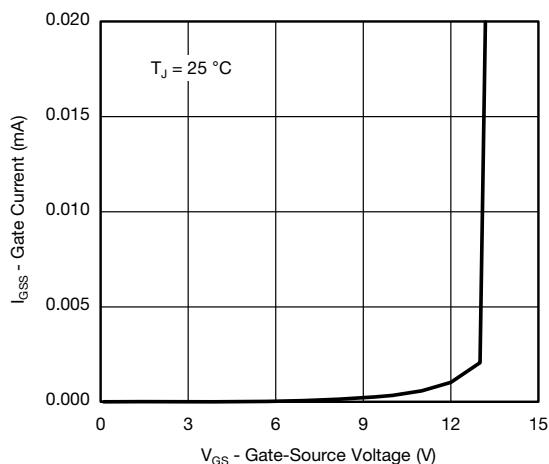
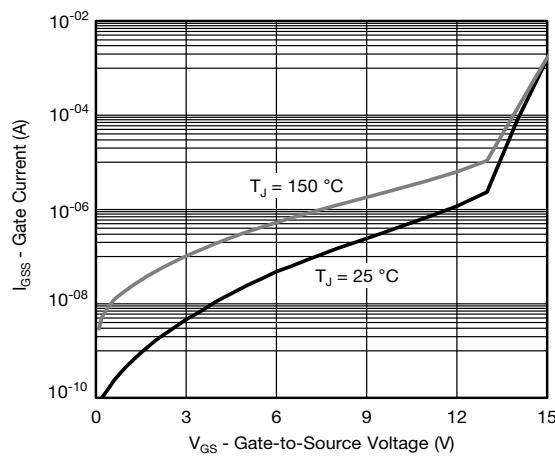
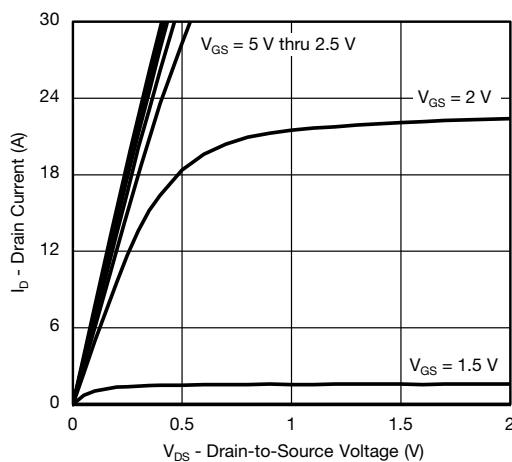
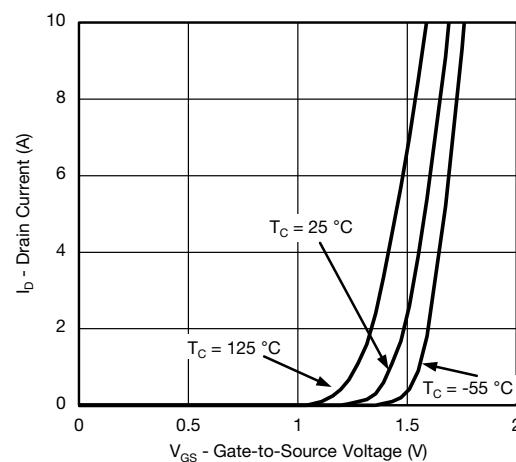
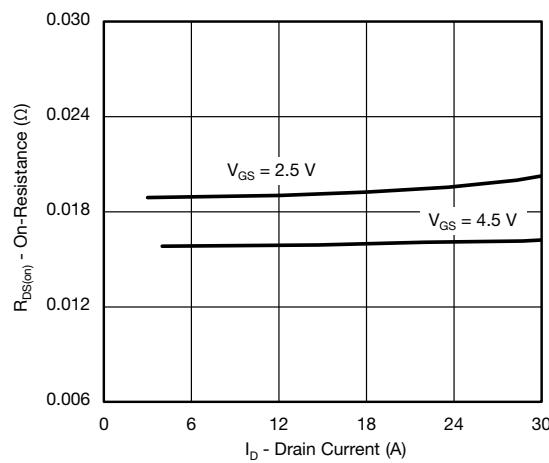
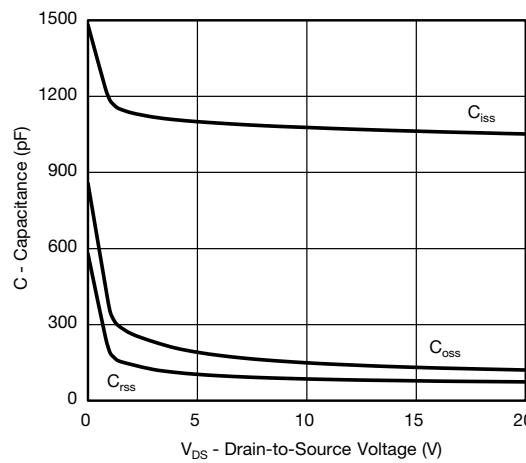
- Package limited.
- Surface mounted on 1" x 1" FR4 board.
- t = 5 s.
- See solder profile ([www.vishay.com/doc?273257](http://www.vishay.com/doc?273257)). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
- Maximum under steady state conditions is 80 °C/W.

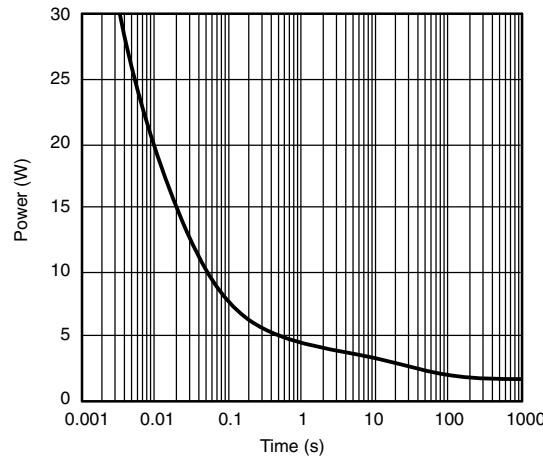
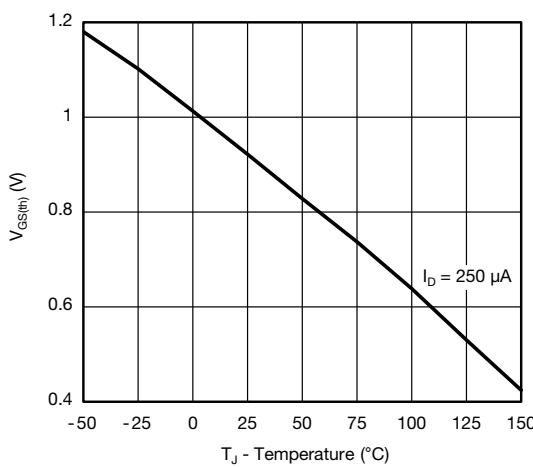
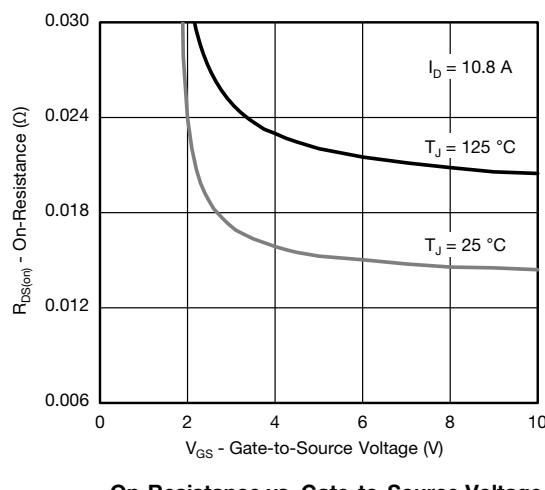
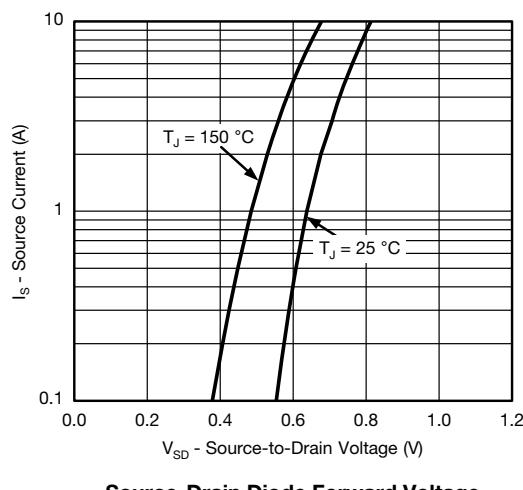
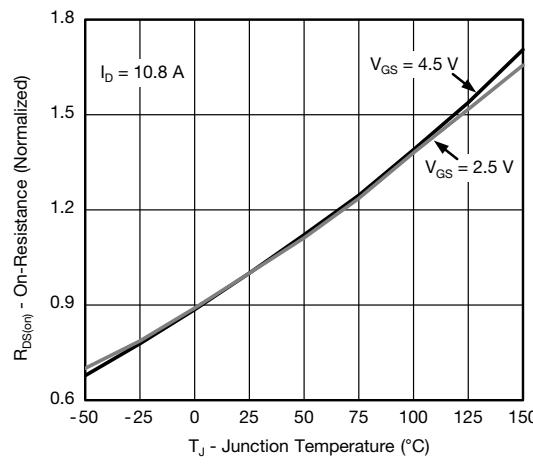
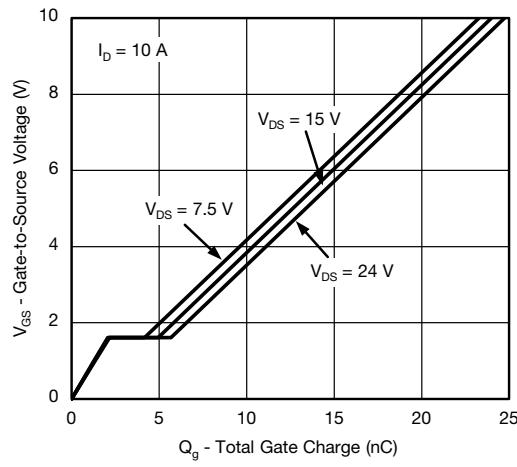
<b>SPECIFICATIONS</b> ( $T_J = 25^\circ\text{C}$ , unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0$ , $I_D = 250 \mu\text{A}$	30	-	-	V
$V_{DS}$ Temperature Coefficient	$\Delta V_{DS}/T_J$	$I_D = 250 \mu\text{A}$	-	34	-	$\text{mV}^\circ\text{C}$
$V_{GS(\text{th})}$ Temperature Coefficient	$\Delta V_{GS(\text{th})}/T_J$		-	-3.8	-	
Gate-Source Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}$ , $I_D = 250 \mu\text{A}$	0.6	-	1.5	V
Gate-Source Leakage	$I_{GSS}$	$V_{DS} = 0 \text{ V}$ , $V_{GS} = \pm 12 \text{ V}$	-	-	$\pm 15$	$\mu\text{A}$
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 30 \text{ V}$ , $V_{GS} = 0 \text{ V}$	-	-	1	$\mu\text{A}$
		$V_{DS} = 30 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $T_J = 55^\circ\text{C}$	-	-	10	
On-State Drain Current <sup>a</sup>	$I_{D(\text{on})}$	$V_{DS} \geq 5 \text{ V}$ , $V_{GS} = 10 \text{ V}$	20	-	-	A
Drain-Source On-State Resistance <sup>a</sup>	$R_{DS(\text{on})}$	$V_{GS} = 4.5 \text{ V}$ , $I_D = 10.8 \text{ A}$	-	0.0167	0.0200	$\Omega$
		$V_{GS} = 2.5 \text{ V}$ , $I_D = 9.4 \text{ A}$	-	0.0200	0.0263	
Forward Transconductance <sup>a</sup>	$g_{fs}$	$V_{DS} = 10 \text{ V}$ , $I_D = 11 \text{ A}$	-	50	-	S
<b>Dynamic <sup>b</sup></b>						
Input Capacitance	$C_{iss}$	$V_{DS} = 15 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $f = 1 \text{ MHz}$	-	1265	-	$\text{pF}$
Output Capacitance	$C_{oss}$		-	132	-	
Reverse Transfer Capacitance	$C_{rss}$		-	80	-	
Total Gate Charge	$Q_g$	$V_{DS} = 15 \text{ V}$ , $V_{GS} = 10 \text{ V}$ , $I_D = 10 \text{ A}$	-	24	36	$\text{nC}$
			-	11.6	17.4	
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 15 \text{ V}$ , $V_{GS} = 4.5 \text{ V}$ , $I_D = 10 \text{ A}$	-	2.9	-	
Gate-Drain Charge	$Q_{gd}$		-	2.2	-	
Gate Resistance	$R_g$	$f = 1 \text{ MHz}$	0.6	3.3	6.6	$\Omega$
Turn-On Delay Time	$t_{d(\text{on})}$	$V_{DD} = 15 \text{ V}$ , $R_L = 1.7 \Omega$ $I_D \approx 8.6 \text{ A}$ , $V_{GEN} = 4.5 \text{ V}$ , $R_g = 1 \Omega$	-	10	15	$\text{ns}$
Rise Time	$t_r$		-	23	35	
Turn-Off Delay Time	$t_{d(\text{off})}$		-	26	39	
Fall Time	$t_f$		-	9	18	
Turn-On Delay Time	$t_{d(\text{on})}$		-	4	8	
Rise Time	$t_r$		-	14	21	
Turn-Off Delay Time	$t_{d(\text{off})}$	$V_{DD} = 15 \text{ V}$ , $R_L = 1.7 \Omega$ $I_D \approx 8.6 \text{ A}$ , $V_{GEN} = 10 \text{ V}$ , $R_g = 1 \Omega$	-	25	38	$\text{ns}$
Fall Time	$t_f$		-	9	18	
<b>Drain-Source Body Diode Characteristics</b>						
Continuous Source-Drain Diode Current	$I_S$	$T_C = 25^\circ\text{C}$	-	-	12	$\text{A}$
Pulse Diode Forward Current	$I_{SM}$		-	-	30	
Body Diode Voltage	$V_{SD}$	$I_S = 8.6 \text{ A}$ , $V_{GS} = 0 \text{ V}$	-	0.8	1.2	V
Body Diode Reverse Recovery Time	$t_{rr}$	$I_F = 8.6 \text{ A}$ , $dl/dt = 100 \text{ A}/\mu\text{s}$ , $T_J = 25^\circ\text{C}$	-	15	23	$\text{ns}$
Body Diode Reverse Recovery Charge	$Q_{rr}$		-	7	14	
Reverse Recovery Fall Time	$t_a$		-	9	-	
Reverse Recovery Rise Time	$t_b$		-	6	-	

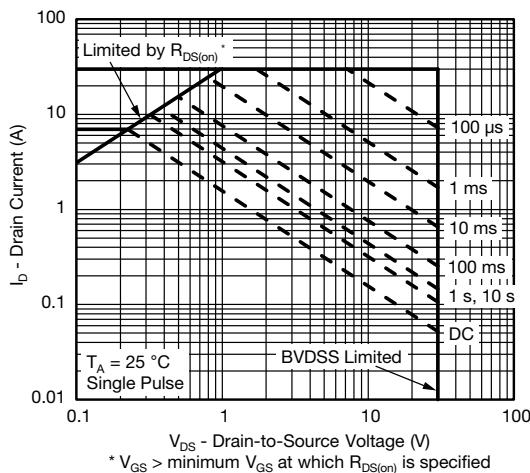
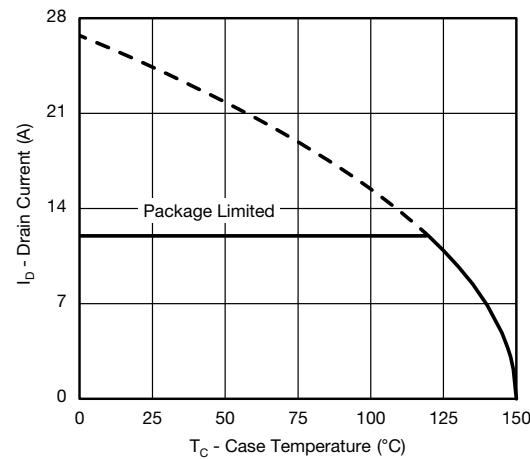
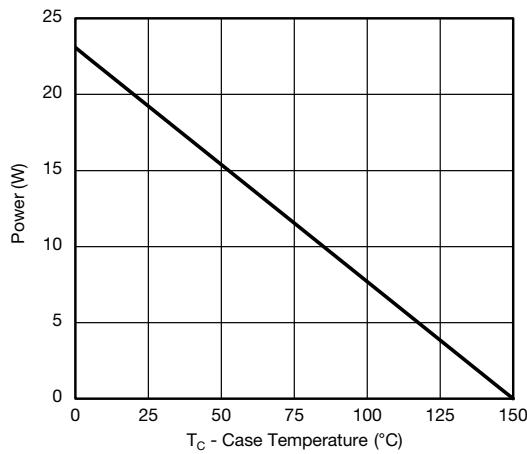
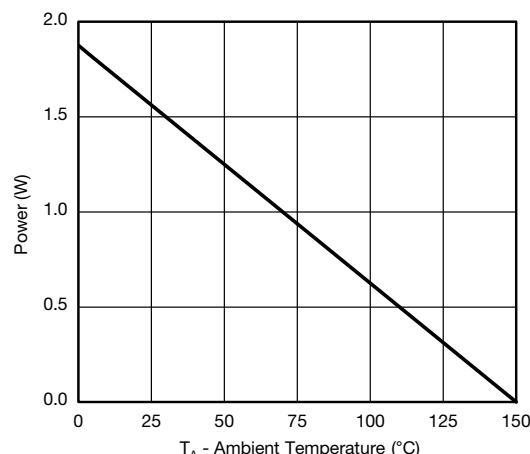
**Notes**

- Pulse test; pulse width  $\leq 300 \mu\text{s}$ , duty cycle  $\leq 2 \%$ .
- Guaranteed by design, not subject to production testing.

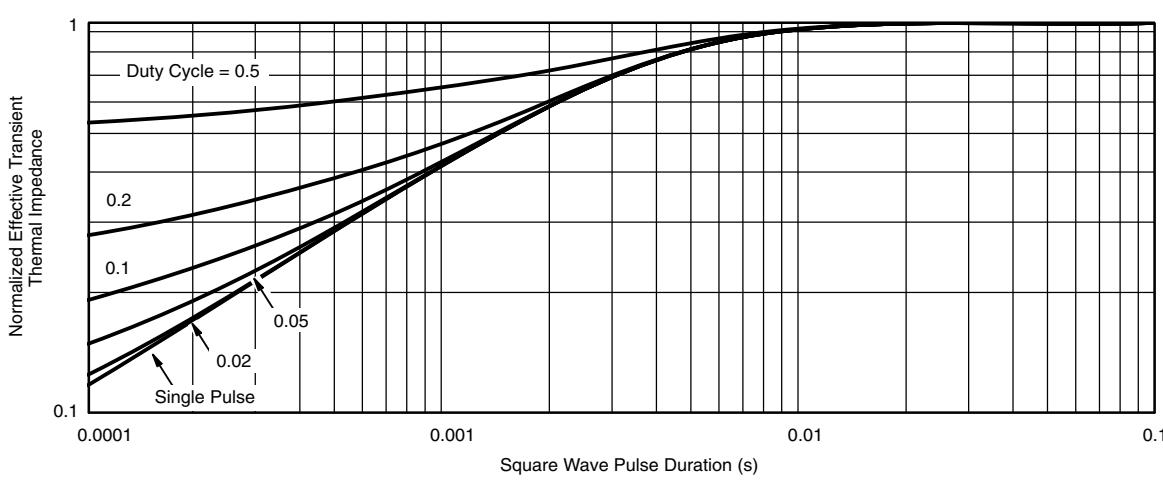
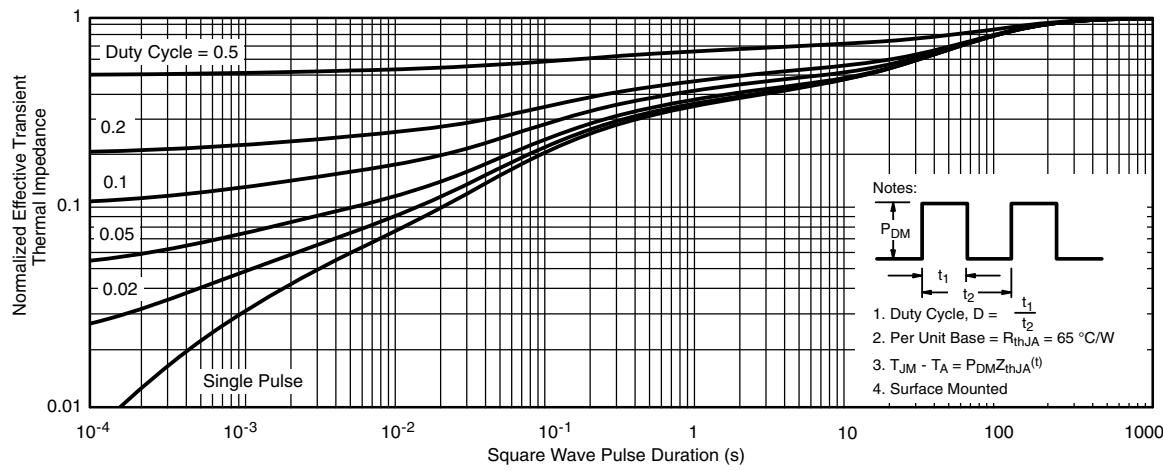
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)

**Gate Current vs. Gate-Source Voltage**

**Gate Current vs. Gate-Source Voltage**

**Output Characteristics**

**Transfer Characteristics**

**On-Resistance vs. Drain Current and Gate Voltage**

**Capacitance**

**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)


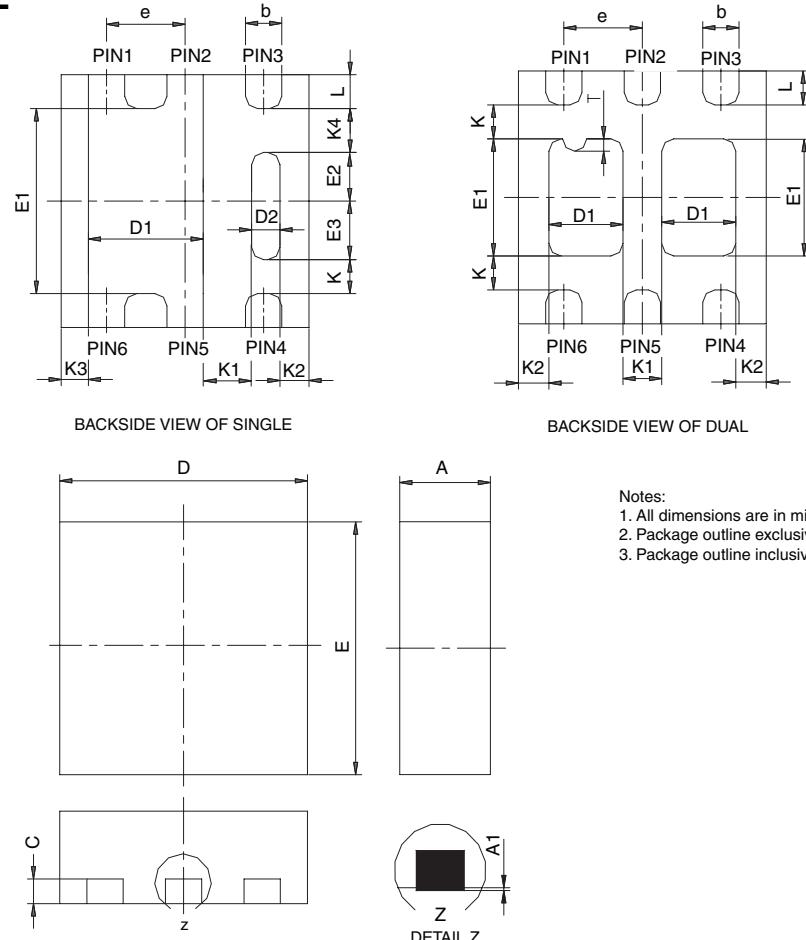
**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)

**Safe Operating Area, Junction-to-Ambient**

**Current Derating <sup>a</sup>**

**Power, Junction-to-Case**

**Power, Junction-to-Ambient**
**Note**

a. The power dissipation  $P_D$  is based on  $T_J$  (max.) = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)


Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see [www.vishay.com/ppg?67554](http://www.vishay.com/ppg?67554).

### PowerPAK® SC70-6L



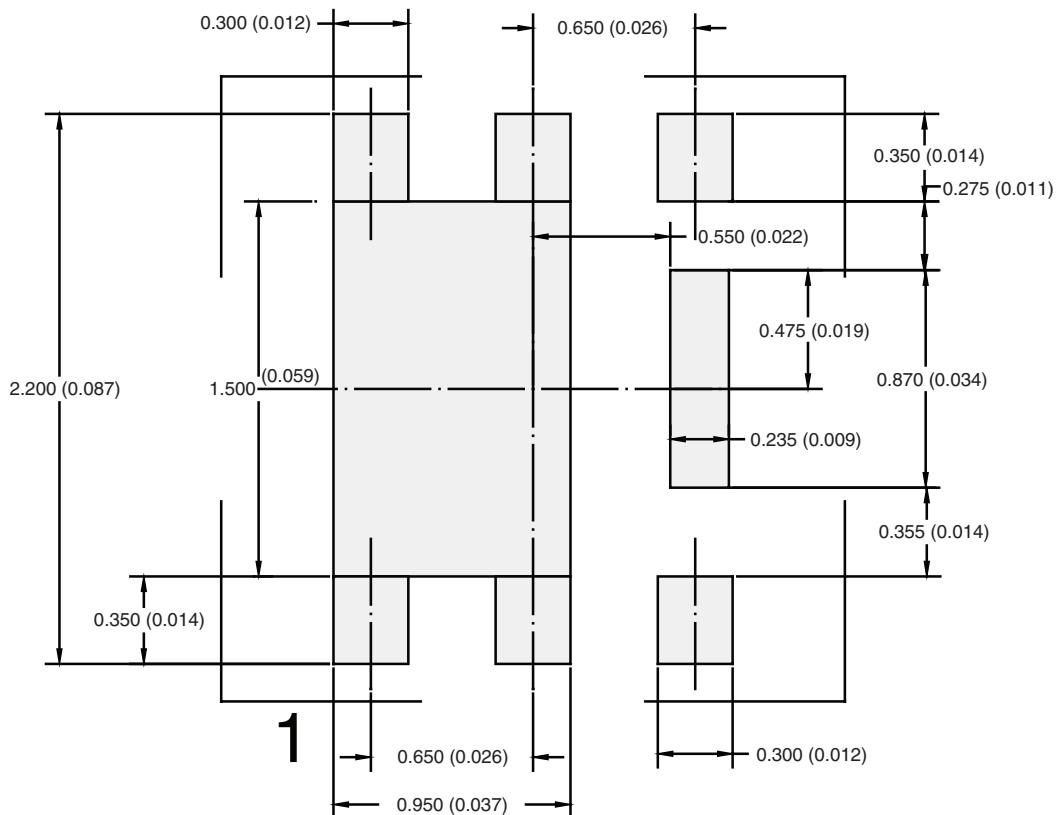
Notes:

1. All dimensions are in millimeters
2. Package outline exclusive of mold flash and metal burr
3. Package outline inclusive of plating

DIM	SINGLE PAD						DUAL PAD					
	MILLIMETERS			INCHES			MILLIMETERS			INCHES		
	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max
A	0.675	0.75	0.80	0.027	0.030	0.032	0.675	0.75	0.80	0.027	0.030	0.032
A1	0	-	0.05	0	-	0.002	0	-	0.05	0	-	0.002
b	0.23	0.30	0.38	0.009	0.012	0.015	0.23	0.30	0.38	0.009	0.012	0.015
C	0.15	0.20	0.25	0.006	0.008	0.010	0.15	0.20	0.25	0.006	0.008	0.010
D	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
D1	0.85	0.95	1.05	0.033	0.037	0.041	0.513	0.613	0.713	0.020	0.024	0.028
D2	0.135	0.235	0.335	0.005	0.009	0.013						
E	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
E1	1.40	1.50	1.60	0.055	0.059	0.063	0.85	0.95	1.05	0.033	0.037	0.041
E2	0.345	0.395	0.445	0.014	0.016	0.018						
E3	0.425	0.475	0.525	0.017	0.019	0.021						
e	0.65 BSC			0.026 BSC			0.65 BSC			0.026 BSC		
K	0.275 TYP			0.011 TYP			0.275 TYP			0.011 TYP		
K1	0.400 TYP			0.016 TYP			0.320 TYP			0.013 TYP		
K2	0.240 TYP			0.009 TYP			0.252 TYP			0.010 TYP		
K3	0.225 TYP			0.009 TYP								
K4	0.355 TYP			0.014 TYP								
L	0.175	0.275	0.375	0.007	0.011	0.015	0.175	0.275	0.375	0.007	0.011	0.015
T							0.05	0.10	0.15	0.002	0.004	0.006

ECN: C-07431 – Rev. C, 06-Aug-07

DWG: 5934

**RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Single**

Dimensions in mm/(Inches)

[Return to Index](#)

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## Material Category Policy

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**Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.**

**Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.**

# Mouser Electronics

Authorized Distributor

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